

Gallium Nitride 28V, 25W RF Power Transistor

Built using the SIGANTIC® NRF1 process - A proprietary GaN-on-Silicon technology

FEATURES

- Optimized for broadband operation from DC-4000MHz
- 25W P_{3dB} CW power at 3000MHz
- 16-20W P_{3dB} CW power from 1000-2500MHz in application board with >45% drain efficiency
- 10-20W P_{3dB} CW power from 30-1000MHz in application board with >50% drain efficiency
- High efficiency from 14 28V
- 4.0 °C/W R_{TH} with maximum T_J rating of 200 °C
- Robust up to 10:1 VSWR mismatch at all angles with no device damage at 90 °C flange
- Subject to EAR99 export control

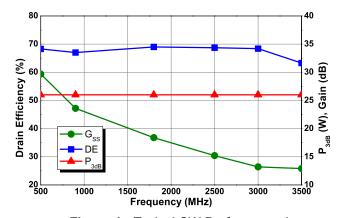


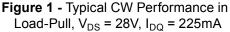
DC – 4000 MHz 25 Watt, 28 Volt GaN HEMT



RF Specifications (CW, 3000MHz): V_{DS} = 28V, I_{DQ} = 225mA, T_C = 25°C, Measured in Nitronex Test Fixture

Symbol	Parameter	Min	Тур	Max	Units
P _{3dB}	Average Output Power at 3dB Gain Compression	43	44	-	dBm
P _{1dB}	Average Output Power at 1dB Gain Compression	-	43	ı	dBm
G _{SS}	Small Signal Gain	12	13	-	dB
η	Drain Efficiency at 3dB Gain Compression	57	65	-	%
VSWR	10:1 VSWR at all phase angles	No damage to the device			





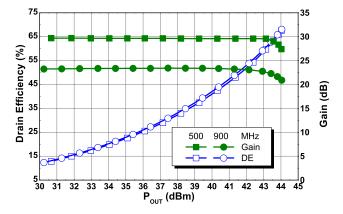


Figure 2 - Typical CW Performance¹ in Load-Pull, V_{DS} = 28V, I_{DQ} = 225mA

Note 1: 500MHz and 900MHz Load-Pull data collected using a 4.7 Ω resistor in the RF path added for stability

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DC Specifications: $T_C = 25^{\circ}C$

Symbol	Parameter	Min	Тур	Max	Units
Off Charact	eristics				
V _{BDS}	Drain-Source Breakdown Voltage (V _{GS} = -8V, I _D = 8mA)	100	-	-	V
I _{DLK}	Drain-Source Leakage Current (V _{GS} = -8V, V _{DS} = 60V)	-	-	4	mA
On Characteristics					
V _T	Gate Threshold Voltage (V _{DS} = 28V, I _D = 8mA)	-2.3	-1.8	-1.3	V
V_{GSQ}	Gate Quiescent Voltage (V _{DS} = 28V, I _D = 225mA)	-2.0	-1.5	-1.0	V
R _{ON}	On Resistance (V _{GS} = 2V, I _D = 60mA)	-	0.44	0.55	Ω
I _{D,MAX}	Drain Current $(V_{DS} = 7V \text{ pulsed}, 300\mu\text{s pulse width}, 0.2\% \text{ duty cycle, } V_{GS} = 2.0V)$	-	5.4	-	А

Thermal Resistance Specification

Symbol	Parameter	Min	Тур	Max	Units
$\theta_{\sf JC}$	Thermal Resistance (Junction-to-Case), $T_J = 180 ^{\circ}\text{C}$	-	4.0	1	°C/W

Absolute Maximum Ratings: Not simultaneous, T_C = 25°C unless otherwise noted

Symbol	Parameter	Max	Units
V _{DS}	Drain-Source Voltage	100	V
V _{GS}	Gate-Source Voltage	-10 to 3	V
I _G	Gate Current	40	mA
P _T	Total Device Power Dissipation (Derated above 25°C)	44	W
T _{STG}	Storage Temperature Range	-65 to 150	°C
T_J	Operating Junction Temperature	200	°C
НВМ	Human Body Model ESD Rating (per JESD22-A114)	1B (+/-500V)	
MM	Machine Model ESD Rating (per JESD22-A115)	A (>100V)	
CDM	Charge Device Model ESD Rating (per JESD22-C101)	IV (>1000V)	

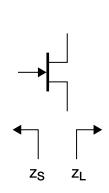


 V_{DS} =28V, I_{DQ} =225mA, T_A =25°C unless otherwise noted

Table 1: Optimum Source and Load Impedances1 for CW Gain, Drain Efficiency, and Output Power Performance

Frequency (MHz)	V _{DS} (V)	Z _S (Ω)	Z L (Ω)	P _{SAT} (W)	G _{SS} (dB)	Drain Efficiency @ P _{SAT} (%)
500	14	7.0 + j8.2	8.6 + j7.4	12	27.8	76
500	22	7.0 + j8.2	9.7+ j11.3	21	29.2	74
500	28	7.0 + j8.2	9.7 + j14.1	26	29.7	68
900	14	5.8 + j3.1	6.8 + j4.7	12	22.4	74
900	22	5.8 + j3.1	9.6 + j5.3	24	23.3	74
900	28	5.8 + j3.1	9.8 + j 7.8	26	23.6	67
1800	28	3.5 - j3.6	6.9 + j2.0	26	18.4	69
2500	14	3.9 - j7.5	6.2 - j8.0	13	13.7	70
2500	22	4.8 - j7.0	5.5 - j4.1	19	14.9	69
2500	28	4.8 - j7.0	5.5 - j4.1	26	15.2	69
3000	28	5.3 - j8.8	5.3 - j6.4	26	13.2	66
3500	28	5.0 - j14.5	7.0 - j9.5	26	12.9	63

Note 1: 500MHz and 900MHz Load-Pull data collected using a 4.7 Ω resistor in the RF path added for stability



Z_S is the source impedance presented to the device. Z_L is the load impedance presented to the device.

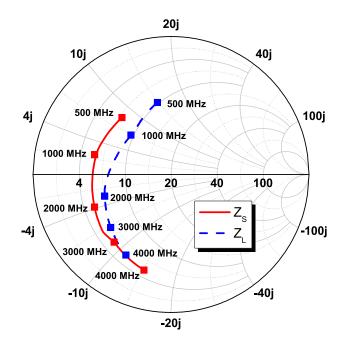
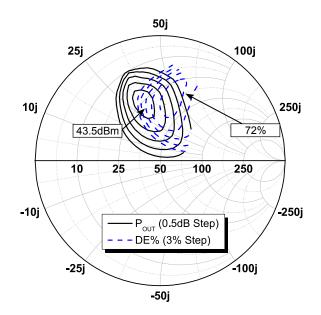


Figure 3 - Optimum Impedances for CW Performance, V_{DS} = 28V



 V_{DS} =28V, I_{DQ} =225mA, T_A =25°C unless otherwise noted



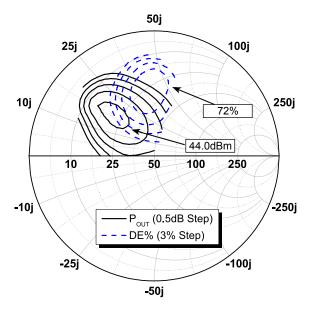
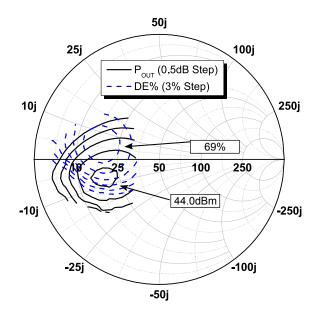
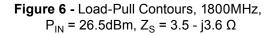


Figure 4 - Load-Pull Contours¹, 500MHz, P_{IN} = 14.5dBm, Z_S = 7.0 + j8.2 Ω

Figure 5 - Load-Pull Contours¹, 900MHz, P_{IN} = 21.0dBm, Z_S = 5.8 + j3.1 Ω

Note 1: 500MHz and 900MHz Load-Pull data collected using a 4.7 Ω resistor in the RF path added for stability





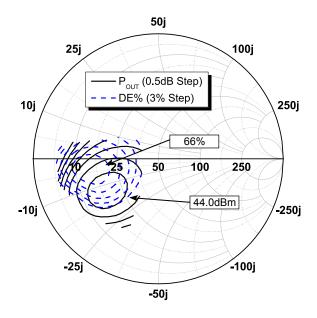


Figure 7 - Load-Pull Contours, 2500MHz, P_{IN} = 29.4dBm, Z_S = 4.8 - j7.0 Ω



V_{DS}=28V, I_{DQ}=225mA, T_A=25°C unless otherwise noted

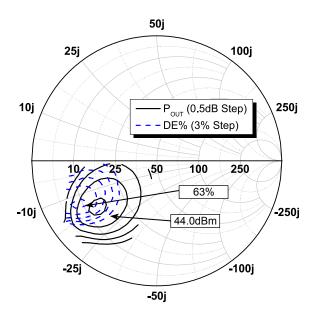


Figure 8 - Load-Pull Contours, 3000MHz, P_{IN} = 31.7dBm, Z_S = 5.3 - j8.8 Ω

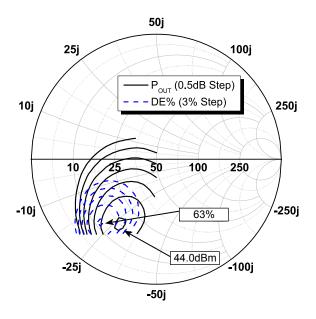


Figure 9 - Load-Pull Contours, 3500MHz, P_{IN} = 33.5dBm, Z_S = 5.0 - j14.5 Ω

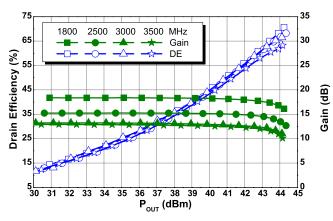


Figure 10 - Typical CW Performance in Load-Pull

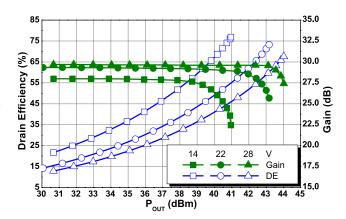


Figure 11 - Typical CW Performance¹ Over Voltage in Load-Pull, 500MHz

Note 1: 500MHz and 900MHz Load-Pull data collected using a 4.7 Ω resistor in the RF path added for stability



V_{DS}=28V, I_{DQ}=225mA, T_A=25°C unless otherwise noted

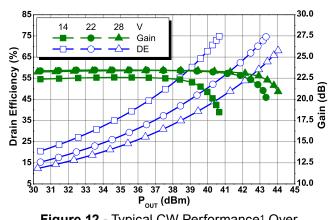


Figure 12 - Typical CW Performance¹ Over Voltage in Load-Pull, 900MHz

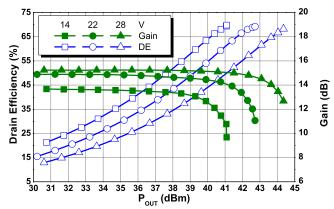


Figure 13 - Typical CW Performance Over Voltage in Load-Pull, 2500MHz

Note 1: 500MHz and 900MHz Load-Pull data collected using a 4.7 Ω resistor in the RF path added for stability

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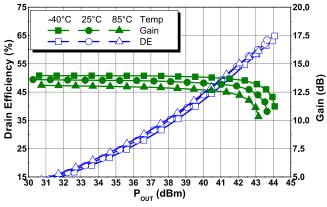


Figure 14 - Typical CW Performance Over Temperature in Nitronex Test Fixture, 3000MHz

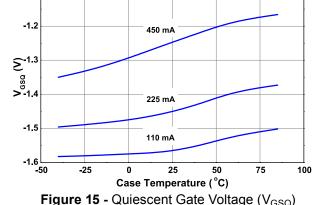


Figure 15 - Quiescent Gate Voltage (V_{GSQ}) Required to Reach I_{DQ} as a Function of Case Temperature, V_{DS} = 28V

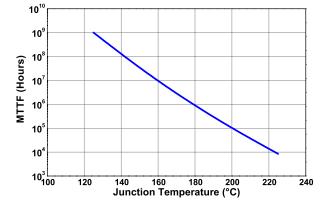


Figure 16 - MTTF of NRF1 Devices as a Function of Junction Temperature

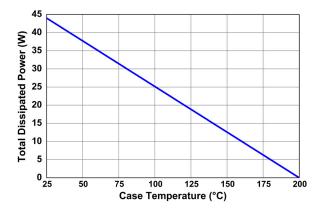


Figure 17 - Power Derating Curve

NPT1012



Ordering Information¹

Part Number	Description
NPT1012B	NPT1012 in AC200B-2 Metal-Ceramic Bolt-Down Package

^{1:} To find a Nitronex contact in your area, visit our website at http://www.nitronex.com

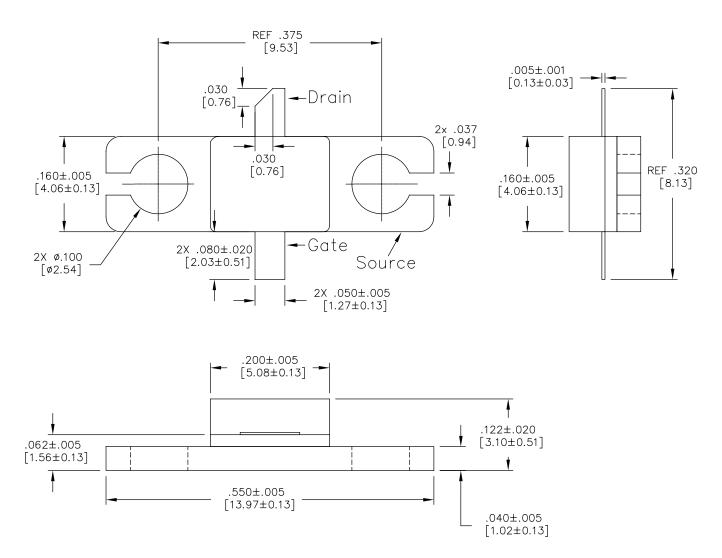


Figure 18 - AC200B-2 Metal-Ceramic Package Dimensions and Pinout (all dimensions are in inches [mm])

NPT1012



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Additional Information

This part is lead-free and is compliant with the RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

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